	TET ESTEL AS ESTONIA	**June** **2013**

Series
TFI172-200

Fast Stud Mounted Thyristor
Type TFI172-200

Low turn-off time
Low reverse recovery charge
Distributed amplified gate for high di/dt

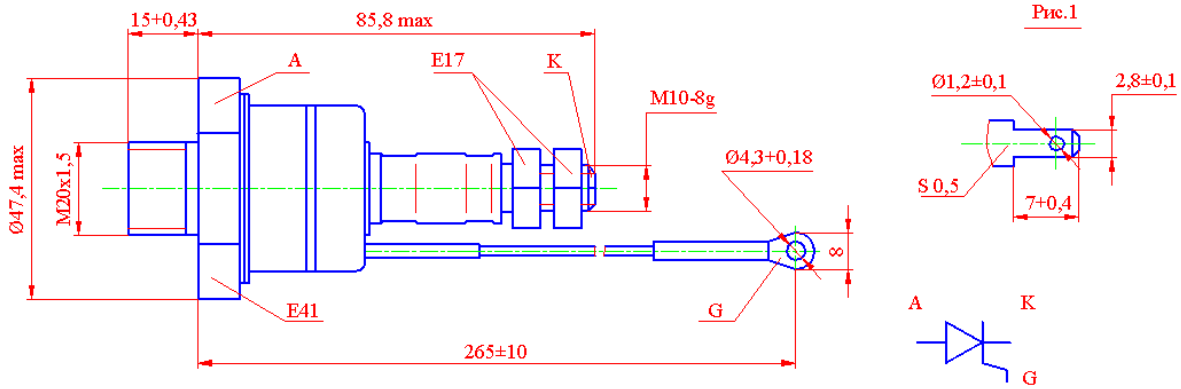
Maximum mean on-state current					**I_{TAV}**	**200 A**			
Maximum repetitive peak off-state and reverse voltage					**U_{DRM}** **U_{RRM}**	**300 ÷1100 V**			
Turn-off time					**tq**	**12,5; 16; 20 µs**			
U_{DRM}, U_{RRM}, V	300	400	500	600	700	800	900	1000	1100
Voltage code	3	4	5	6	7	8	9	10	11
Tvj, °C	- 60 ÷ 125								

MAXIMUM ALLOWABLE RATINGS					
Symbols and parameters		Units	TFI172-200	Conditions	
I_{TAV}	Mean on-state current	A	200	Tc=95 °C, 180° half-sine wave, 50 Hz	
I_{TRMS}	RMS on-state current	A	314	Tc=95 °C	
I_{TSM}	Surge on-state current	kA	6,0 6,6	Tvj=125°C Tvj=25°C	tp=10 ms U_R=0
I^2t	Limiting load integral	kA^2s	180 217	Tvj=125°C Tvj=25°C	
U_{DRM},U_{RRM}	Repetitive peak off-state and reverse voltage	V	300÷1100	Tj min≤Tvj≤Tjm 180° half-sine wave, 50 Hz Gate open	
U_{DSM},U_{RSM}	Non-repetitive peak off-state and reverse voltage	V	330÷1210	Tj min≤Tvj≤Tjm 180° half-sine wave tp=10 ms, Single pulse Gate open	
(di$_T$/dt) crit	Critical rate of rise of on-state current : non - repetitive repetitive	A/µs	 1600 800	Tvj=125°C ; U_D=0,67 U_{DRM}, Gate pulse : 10V,5 Ω, 1µs rise time, 10 µs	
U_{RGM}	Peak reverse gate voltage	V	5	Tj min≤Tvj≤Tjm	
Tstg	Storage temperature	°C	-60÷80		
Tvj	Junction temperature	°C	-60÷125		
CHARACTERISTICS					
U_{TM}	Peak on-state voltage	V	2,1	Tvj=25°C, I_{TM}=3,14 I_{TAV}	
$U_{T(TO)}$	Threshold voltage	V	1,4	Tvj=125°C 1,57 I_{TAV}< I_T <4,71 I_{TAV}	
R_T	On-state slope resistance	mΩ	0,75		
I_{DRM} I_{RRM}	Repetitive peak off-state and reverse current	mA	 50 50	Tvj=125°C, U_D = U_{DRM} U_R= U_{RRM}	

CHARACTERISTICS					
Symbols and parameters		Units	TFI172-200	Conditions	
I_L	Latching current	A	5	Tvj=25°C,U_D=12V Gate pulse : 10V, 5Ω, 1 µs rise time, 10µs	
I_H	Holding current	A	0,3	Tvj=25°C,U_D=12V, Gate open	
U_{GT}	Gate trigger direct voltage	V	2,5 5,0	Tvj=25°C, Tvj=-60°C	U_D=12V
I_{GT}	Gate trigger direct current	A	0,3 0,85	Tvj=25°C, Tvj=-60°C	
U_{GD}	Gate non-trigger direct voltage	V	0,25	Tvj=125°C, U_D = 0,67 U_{DRM}	
I_{GD}	Gate non-trigger direct current	мA	10	Direct gate current	
tgd	Delay time	µs	1,0 ÷1,6	Tvj=25°C,U_D=300V I_{TM} = 200 A Gate pulse : 10V, 5Ω, 1 µs rise time, 10µs	
tgt	Turn-on time	µs	1,6 ÷2,5		
tq	Turn-off time	µs	12,5 ÷20	Tvj=125°C, I_{TM}=200 A di_R/dt =10 A/µs, U_R=100V U_D = 0,67 U_{DRM} du_D/dt=50 V/µs	
Qrr	Recovered charge	µC	100	Tvj=125°C, I_{TM}=200 A di_R/dt=50 A/µs, U_R=100V	
trr	Reverse recovery time	µs	3,1		
I_{RRM}	Peak reverse recovery current	A	70		
$(du_D/dt)_{crit}$	Critical rate of rise of off-state voltage	V/µs	500 1000	Tvj=125°C, U_D = 0,67 U_{DRM} Gate open	
Rthjc	Thermal resistance junction to case	°C/W	0,075	Direct current	

ORDERING								
	TFI	**172**	**200**	**10**	**7**	**8**	**3**	
	1	**2**	**3**	**4**	**5**	**6**	**7**	

1. Fast thyristor with interdigitated gate structure.
2. Design version.
3. Mean on-state current, A.
4. Voltage code (10=1000 V).
5. Critical rate of rise of off-state voltage (6 ≥ 500 V/µs, 7 ≥1000 V/µs).
6. Group of turn-off time (du_D/dt=50 V/µs, 6 ≤ 20µs, 7 ≤ 16µs, 8 ≤ 12,5µs).
7. Group of turn-on time (3 ≤ 2,5µs, 4 ≤ 2,0µs, 5≤ 1,6µs).



Tightening torgue : 40 ÷ 60 Nm
Weight : 380 grams
Mounting of thyristors with a rigid cathode gate should be carried through a flexible conductor.